

ELECTRONIC INFORMATION DISCLOSURE STATEMENT

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| Title of Invention | SOLDER INTERCONNECTION ARRAY WITH OPTIMAL MECHANICAL INTEGRITY | | | | | | |
|--------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------|------------|------------|--------------------|------|-------|----------|
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| Confirmation Number: | | | | | | | |
| First Named Applicant: | Glenn Daves | | | | | | |
| Attorney Docket Number: | FIS920040002US1 | | | | | | |
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| Examiner: | | | | | | | |
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| US Patent Documents | | | | | | | |
| Note: Applicant is not required to submit a paper copy of cited US Patent Documents | | | | | | | |
| init | Cite.No. | Patent No. | Date | Patentee | Kind | Class | Subclass |
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| Signature | | | | | | | |
| Examiner Name | | | | Date | | | |
| <i>APhms</i> | | | | 10/03/2006 | | | |